IPC - ASSOCIATION CONNECTION ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			ler both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type 'Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
upplier Inforn	nation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi											2023-06-08			
ontact Name		Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repres	entative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
roduct-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Request	er Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	M	lanufacturing Site	W	/eight*	UOM	Unit Type
		NCV70501DW002R2 BIPOLAR STEPPE G		R MOTOR D	RI	2023-06-08 BE4		E4	1	56.31	mg	Each		
lanufacturing	Process Information	on												
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-0			STD-020 MSL	Rating	Peak Proce	ss Body Tei	mperature	Max Time at Peak	Temperatu	re Numb	er of Reflow Cyc	cles		
Matte Tin (Sn) - annealed		C	CU Alloy 2				260		С	30	second	s 3		
omments							·			•				
TTENTION: MS	L 2 Rated item requires	Dry Pack (at	fter electrical	test)										
or more informati	ion regarding material co	omposition r	olease refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Veight Unit of Measure Leve		Substance	CAS	Exempt	Weight	Unit of Measure
Die	8.95	mg	Supplier	Silicon (Si)	7440-21-3		8.95	mg
Die Attach	2.43	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.5589	mg
			Supplier	Silver (Ag)	7440-22-4		1.8711	mg
Lead Frame	58.58	mg	Supplier	Zinc (Zn)	7440-66-6		0.0586	mg
			Supplier	Iron (Fe)	7439-89-6		1.3473	mg
			Supplier	Copper (Cu)	7440-50-8		57.1155	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0586	mg
Mold Compound-Black	93.89	mg		Epoxy Phenol Resin	proprietary data		9.8584	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		84.0315	mg
Plating	1.91	mg	Supplier	Tin (Sn)	7440-31-5		1.91	mg
Wire Bond - Au	0.55	mg	Supplier	Gold (Au)	7440-57-5		0.55	mg